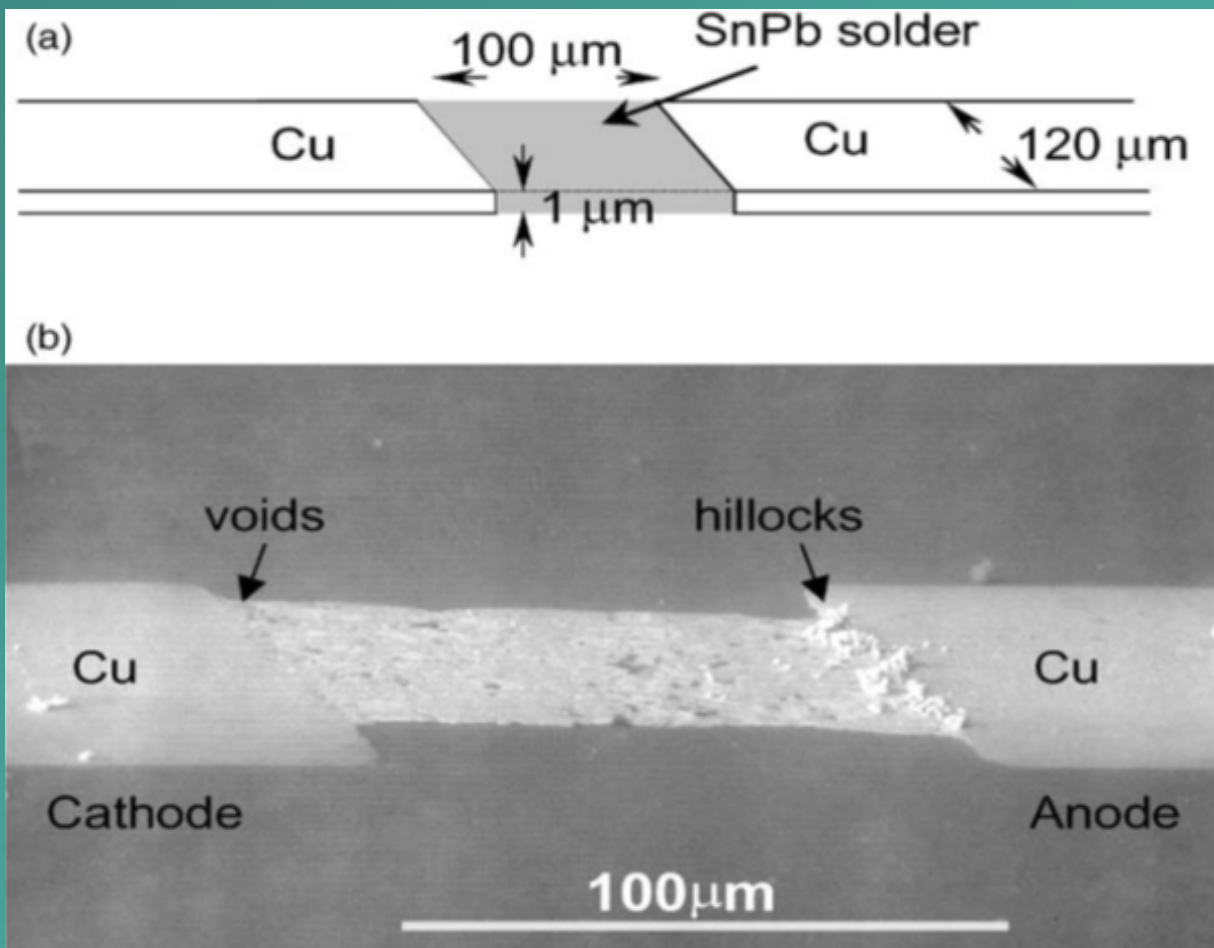


# Journal of Electronics Cooling and Thermal Control



ISSN: 2162-6162



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ISSN 2162-6162 (print) ISSN 2162-6170 (online)

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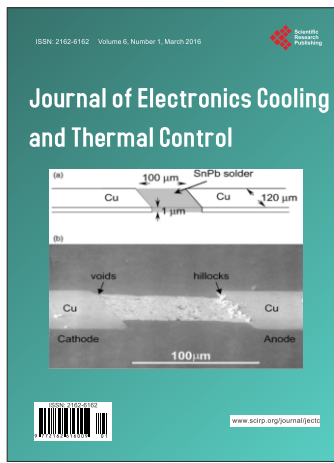
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ISSN 2162-6162 (print) ISSN 2162-6170 (online)

<http://www.scirp.org/journal/jectc>

**Journal of Electronics Cooling and Thermal Control (JECTC)** is a quarterly, peer-reviewed, academic journal. It aims to provide a vehicle for the exchange and dissemination of original research results, technical notes, and state-of-the-art reviews pertaining to the electronic cooling and thermal system control technology in the computer and electronics industries.

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